

- NOTE:
1. MATERIAL, HOUSING: HIGH TEMP PLASTIC, UL94-V0, BLACK TERMINAL: COPPER ALLOY, SQ=0.40±0.03MM
 2. FINISH: TERMINAL: GOLD AT CONTACT, G/F OVER 1um(40u") MIN NI OVER ALL
 3. SPEC.: PRODUCT SPEC: GS-12-629 PACKING SPEC: GS-14-1420
 4. THE HSG. WILL WITHSTAND EXPOSURE TO 260°C PEAK TEMP. FOR 10 SEC. IN A CONNECTION INFRARED OR VAPOR PHASE REFLOW OVEN.
 5. THE TOLERANCE OF THIS DIMENSION
- | | |
|------------|--------|
| 2-60 PINS | ± 0.20 |
| 62-98 PINS | ± 0.30 |

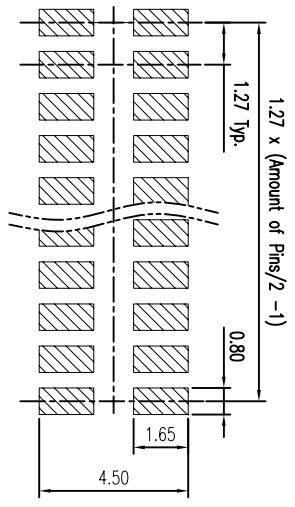
6. PRODUCT NUMBERING:
20021122 - 0 0 0 XX X X LF

LEAD FREE

PLATING:
1:GOLD FLASH ALL OVER
4:0.25um(10u")GOLD AT CONTACT
8:0.76um(30u")GOLD AT CONTACT
9:1u" GOLD OVER 30u" PdNi AT CONTACT

PACKING

T: TUBE
D: TUBE + CAP
C: REEL + CAP
PIN COUNT
06,08,10,...., 98
(8 -98 EVERY EVEN PIN)



Recommended P.C.B. Layout
Layout Tolerance = ± 0.05 mm

mat'l. code	surf. code	tolerance	projection	product family
ISO1302	ISO1001 ISO406	MM	MINITEK	
1tr	ecm no	dr	date	tolerances unless otherwise specified
A	T09-1117S.LIN	09/15/09	angles g	0.X±0.38
B	T09-1155S.LIN	12/03/09	g	0.XX±0.25
C	T10-0014S.LIN	01/28/10	0°±Z	0.XXX±0.10
D	T11-0029S.LIN	06/14/11	dr	STERLING LIN 09/15/09
E	DX-K-0039	ZK 01/16/12	enjt	STERLING LIN 09/15/09
F	DX-K-0089	ZK 03/12/12	chr	GRAY HSEH 09/15/09
G	DX-K-1646	TIM 12/06/13	dpd	JOSEPH 09/15/09
sheet index	revision	G		
sheet index	sheet	1		



1.27X1.27MM BTB HEADER
UNSHROUDED SMT
20021122
sheet: 1 of 1
size A4